## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4411530

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
ZHAOWEI JIA	04/19/2017
DONGFENG XIAO	04/27/2017
JIAN WANG	04/20/2017
HUI WANG	04/27/2017

### **RECEIVING PARTY DATA**

Name:	ACM RESEARCH (SHANGHAI) INC.	
Street Address:	Address: BUILDING 4, NO. 1690 CAI LUN ROAD	
Internal Address:	nternal Address: ZHANGJIANG HIGH-TECH PARK, PUDONG DISTRICT	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201203	

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15518817

#### **CORRESPONDENCE DATA**

**Fax Number:** (713)228-8778

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 7132288600

Email: sun@oshaliang.com
Correspondent Name: JEFFERY P. LANGER

Address Line 1: TWO HOUSTON CENTER - SUITE 3500

Address Line 2: 909 FANNIN ST.

Address Line 4: HOUSTON, TEXAS 77010

ATTORNEY DOCKET NUMBER:	17433/039001
NAME OF SUBMITTER:	BAIWEI SUN
SIGNATURE:	/Jeffery P. Langer/
DATE SIGNED:	05/10/2017

**Total Attachments: 2** 

PATENT REEL: 042354 FRAME: 0855

504364838

source=assignment039#page1.tif source=assignment039#page2.tif

> PATENT REEL: 042354 FRAME: 0856

### ASSIGNMENT - U. S. RIGHTS ONLY

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned individual(s) (referred to herein as the "INVENTOR(S)") hereby assign, transfer, and set over to:

ACM Research (Shanghai) Inc.

having the following address:

Building 4, No.1690, Cai Lun Road Zhangjiang High-Tech Park, Pudong District Shanghai 201203 PEOPLE'S REPUBLIC OF CHINA

(referred to herein as "COMPANY"), its successors, and assigns, the entire right, title, and interest for the United States of America (including without limitation its territories and possessions) in and to the invention known by the following title:

# BARRIER LAYER REMOVAL METHOD AND SEMICONDUCTOR STRUCTURE FORMING METHOD

for which the INVENTOR(S) or COMPANY has/have made an application for patent in the United States of America, together with said patent application, all divisions, continuations, continuations-in-part, reissues, and extensions thereof, and all United States Letters Patent which may be granted therefor. Such interest represents the entire ownership of said applications and Letters Patent when granted and is to be owned by COMPANY, its successors, and assigns, or their legal representatives, for the full and entire term for which such Letters Patent may be granted or extended, as fully and entirely as the same would have been enjoyed by the INVENTOR(S) if this assignment had not been made.

In addition, the undersigned INVENTOR(S) each hereby agrees:

- 1. To sign and execute any further documents which may be necessary or desirable, lawful, and proper in connection with the prosecution of all applications for patent(s) on the INVENTION in the United States, including without limitation said application and all divisions, continuations, continuations-in-part, amendments thereof, and all interference proceedings associated therewith, or otherwise necessary or desirable to secure the title thereto to COMPANY;
- To execute all papers and documents and to perform all lawful acts which may be necessary in connection with claims to priority or otherwise under the International Convention for the Protection of Industrial Property or similar treaties or agreements;
- 3. To perform all lawful affirmative acts which may be necessary to obtain the grant of a valid and enforceable patent to COMPANY.

The undersigned INVENTOR(S) each hereby authorizes and requests the Commissioner of Patents and Trademarks in the United States to issue any and all Letters Patent resulting from said application, including without limitation any division, continuation, continuation-in-part, or reissue thereof to COMPANY.

The undersigned INVENTOR(S) each hereby grants to the firm of OSHA LIANG LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for the recordation of this document.



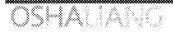
PATENT REEL: 042354 FRAME: 0857

	IN WITNESS WHE		
	iduals on the date appearing b mil. 19, 7017	y such individual's signature	Zhane'i Ji'u Zhaowei Jia
	Date	I* Inventor Signature: Print or Type Name:	Zhaowei Jia
2	07   4   27	2 <sup>rd</sup> Inventor Signature:	h t A
	Date	Print or Type Name:	Dongfeng Xiao
Q.	0.7/4/20	3 <sup>rd</sup> Inventor Signature:	Fion Warz
	Date	Print or Type Name:	∬lian Wang
20	7 / 4 / 7 ] Date	4 <sup>th</sup> Inventor Signature:	
	1 late	Print or Type Name:	Flui Wang
			o or /h) hun witnesses who sino helow
	State of		s, or (b) two witnesses who sign below:
0 2 2 3	State of		s, or (b) two witnesses who sign below:  Dongfeng Xiso  Pisence Hui Wang
IRY PUBLIC	State of	Zhaowei Jia (Shoesto Jian Wang (Shoesto)	Dongfeng Xiso  Placente  His Wang  Stroomer
NOTARY PUBLIC	State of County of Before me personally appeared:	Zhaowei Jia  (* Inventor Jian Wang  (* Inventor  ** Inventor  ** Inventor  ** Inventor	Dongfeng Xiao  2º jacente Hui Wang  3º jacente  5º jacente  8º jacente
NOTARY PUBLIC	State of County of Before me personally appeared:	Zhaowei Jia  (* Inventor Jian Wang  (* Inventor  ** Inventor  ** Inventor  ** Inventor	Dongfeng Xiao  Pipaente Hui Wang  Sinosas
	State of County of Before me personally appeared: each of whom acknowledged the execute this Assignment.	Zhaowei Jia  (* Inventor Jian Wang  ** Inventor  ** Inven	Dongleng Xiao  2º jacenso  Hui Wang  8º jacenso  8º jacenso  8º jacenso  so jacenso  so jacenso  so jacenso  so jacenso  so jacenso  so jacenso  tand deed and also represented that he/she is authorized to
	State of County of Before me personally appeared: each of whom acknowledged the execute this Assignment.  Dated:	Zhaowei Jia  (*Inventor Jian Wang  **Inventor  **Inven	Dongfeng Xiao  ***Parente  ***Parente  ***Parente  ***Parente  ***Parente  ***Parente  ***Inventor  ***Invent
WITNESSES NOTARY PUBLIC	State of County of Before the personally appeared: each of whom acknowledged the execute this Assignment.  Dated:  2077 [ 4 / 28	Zhaowei Jia  (*Investor Jian Wang  *Phoentor  *Phoentor  foregoing instrument to be a free ac  Notary Public  Signature of Witness:	Dongfeng Xiao  Therente  Hui Wang  Shawater  Shawater  st and deed and also represented that he/she is authorized to  My commission expires:

When this Assignment is <u>not</u> filed concurrently with the patent application, the following identifying information may be added <u>after</u> execution:

U.S. Application Serial No.: 15/518,817

Filing Date: April 13, 2017



**RECORDED: 05/12/2017**